

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	V
RMS Reverse Voltage	V _{R(RMS)}	14	V
Average Rectified Output Current @ T _L = +90°C	I ₀	0.5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	5.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	410	mW
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\Theta JA}$	244	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

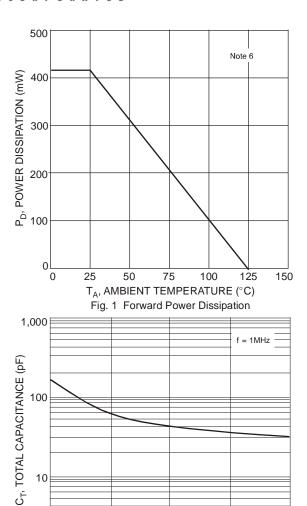
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

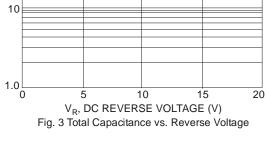
Characteristic	Symbol	Value	Unit	Test Conditions
Minimum Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	20	V	$I_R = 250\mu A$
Maximum Forward Voltage Drop	V _{FM}	0.300 0.385 0.220 0.330	V	$\begin{split} I_F &= 0.1A, \ T_J = +25^{\circ}C \\ I_F &= 0.5A, \ T_J = +25^{\circ}C \\ I_F &= 0.1A, \ T_J = +100^{\circ}C \\ I_F &= 0.5A, \ T_J = +100^{\circ}C \end{split}$
Maximum Leakage Current (Note 8)	I _{RM}	75 250	μA	$V_R = 10V, T_J = +25$ °C $V_R = 20V, T_J = +25$ °C
iviaximum Leanage Guirem (ivote o)	I _{RM}	5.0 8.0	mA	$V_R = 10V, T_J = +100$ °C $V_R = 20V, T_J = +100$ °C
Typical Total Capacitance	C _T	170	pF	$V_R = 0V DC$, $f = 1MHz$

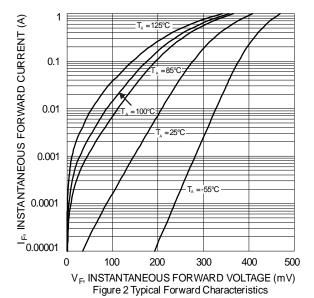
Notes:

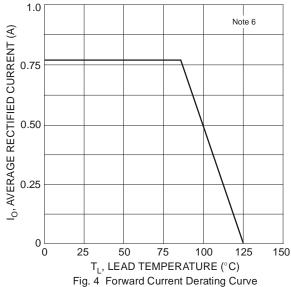
- 6. Device mounted on FR-4 PC board, 2"x 2", 2 oz. Copper, single sided, Cathode pad dimensions 0.75" x 1.0", Anode pad dimensions 0.25" x 1.0".
- 7. Pulse Test: Pulse width = 300μ s, Duty Cycle $\leq 2\%$.
- 8. No purposefully added lead. Halogen and Antimony Free.







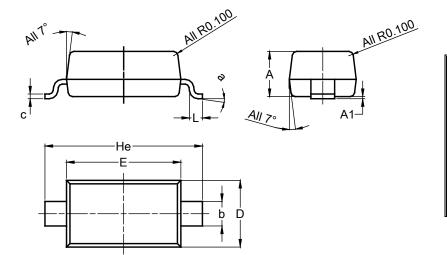






Package Outline Dimensions

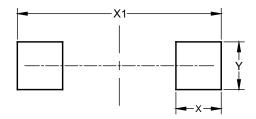
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123			
Dim	Min	Max	Тур
Α	1.00	1.35	1.05
A1	0.00	0.10	0.05
b	0.52	0.62	0.57
С	0.10	0.15	0.11
D	1.40	1.70	1.55
Е	2.55	2.85	2.65
He	3.55	3.85	3.65
L	0.25	0.40	0.30
а	00	8º	
All Dimensions in mm			

Suggested Pad Layout

 $\label{please} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$



Dimensions	Value (in mm)
Х	0.900
X1	4.050
Υ	0.950



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